# **B-Suffix Series CMOS Gates**

The B Series logic gates are constructed with P and N channel enhancement mode devices in a single monolithic structure (Complementary MOS). Their primary use is where low power dissipation and/or high noise immunity is desired.

- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- All Outputs Buffered
- Capable of Driving Two Low–power TTL Loads or One Low–power Schottky TTL Load Over the Rated Temperature Range.
- Double Diode Protection on All Inputs
- Pin–for–Pin Replacements for Corresponding CD4000 Series B Suffix Devices



## ON Semiconductor

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# MARKING DIAGRAMS



PDIP-14 P SUFFIX CASE 646



#### **MAXIMUM RATINGS** (Voltages Referenced to V<sub>SS</sub>) (Note 2.)

Symbol	Parameter	Value	Unit
$V_{DD}$	DC Supply Voltage Range	-0.5 to +18.0	V
V <sub>in</sub> , V <sub>out</sub>	Input or Output Voltage Range (DC or Transient) -0.5 to V <sub>DD</sub> + 0.5		V
I <sub>in</sub> , I <sub>out</sub>	Input or Output Current (DC or Transient) per Pin	±10	mA
P <sub>D</sub>	Power Dissipation, per Package (Note 3.)	500	mW
T <sub>A</sub>	Ambient Temperature Range	-55 to +125	°C
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	°C
TL	Lead Temperature (8–Second Soldering)	260	°C

- Maximum Ratings are those values beyond which damage to the device may occur.
- Temperature Derating: Plastic "P and D/DW" Packages: – 7.0 mW/°C From 65°C To 125°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either  $V_{SS}$  or  $V_{DD}$ ). Unused outputs must be left open.

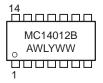


SOIC-14 D SUFFIX CASE 751A





SOEIAJ-14 F SUFFIX CASE 965



A = Assembly Location

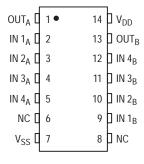
WL or L = Wafer Lot YY or Y = Year WW or W = Work Week

#### ORDERING INFORMATION

Device	Package	Shipping		
MC14012BCP	PDIP-14	2000/Box		
MC14012BD	SOIC-14	55/Rail		
MC14012BDR2	SOIC-14	2500/Tape & Reel		
MC14012BF	SOEIAJ-14	See Note 1.		
MC14012BFEL	SOEIAJ-14	See Note 1.		

 For ordering information on the EIAJ version of the SOIC packages, please contact your local ON Semiconductor representative.

## MC14012B Dual 4-Input NAND Gate



1 3 4 5 9 10 11 12 NC = 6, 8

 $V_{DD} = PIN 14$  $V_{SS} = PIN 7$ 

# NC = NO CONNECTION

### **ELECTRICAL CHARACTERISTICS** (Voltages Referenced to V<sub>SS</sub>)

			V <sub>DD</sub>	- 5	5°C		25°C		125	5°C	
Characteristic		Symbol	Vdc	Min	Max	Min	Typ <sup>(4.)</sup>	Max	Min	Max	Unit
Output Voltage V <sub>in</sub> = V <sub>DD</sub> or 0	"0" Level	V <sub>OL</sub>	5.0 10 15	_ _ _	0.05 0.05 0.05	_ _ _	0 0 0	0.05 0.05 0.05	_ _ _	0.05 0.05 0.05	Vdc
V <sub>in</sub> = 0 or V <sub>DD</sub>	"1" Level	V <sub>OH</sub>	5.0 10 15	4.95 9.95 14.95	_ _ _	4.95 9.95 14.95	5.0 10 15	_ _ _	4.95 9.95 14.95	_ _ _	Vdc
Input Voltage ( $V_O = 4.5 \text{ or } 0.5 \text{ Vdc}$ ) ( $V_O = 9.0 \text{ or } 1.0 \text{ Vdc}$ ) ( $V_O = 13.5 \text{ or } 1.5 \text{ Vdc}$ )	"0" Level	V <sub>IL</sub>	5.0 10 15		1.5 3.0 4.0	=	2.25 4.50 6.75	1.5 3.0 4.0		1.5 3.0 4.0	Vdc
$(V_O = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_O = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_O = 1.5 \text{ or } 13.5 \text{ Vdc})$	"1" Level	V <sub>IH</sub>	5.0 10 15	3.5 7.0 11		3.5 7.0 11	2.75 5.50 8.25	_ _ _	3.5 7.0 11	_ _ _	Vdc
Output Drive Current $ (V_{OH} = 2.5 \text{ Vdc}) $ $ (V_{OH} = 4.6 \text{ Vdc}) $ $ (V_{OH} = 9.5 \text{ Vdc}) $ $ (V_{OH} = 13.5 \text{ Vdc}) $	Source	I <sub>OH</sub>	5.0 5.0 10 15	- 3.0 - 0.64 - 1.6 - 4.2		- 2.4 - 0.51 - 1.3 - 3.4	- 4.2 - 0.88 - 2.25 - 8.8	_ _ _ _	- 1.7 - 0.36 - 0.9 - 2.4	_ _ _ _	mAdc
$(V_{OL} = 0.4 \text{ Vdc})$ $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$	Sink	I <sub>OL</sub>	5.0 10 15	0.64 1.6 4.2	_ _ _	0.51 1.3 3.4	0.88 2.25 8.8	_ _ _	0.36 0.9 2.4	_ _ _	mAdc
Input Current		I <sub>in</sub>	15	_	± 0.1	_	±0.00001	± 0.1	_	± 1.0	μAdc
Input Capacitance (V <sub>in</sub> = 0)		C <sub>in</sub>	_	_	_	_	5.0	7.5	_	_	pF
Quiescent Current (Per Package)		I <sub>DD</sub>	5.0 10 15	_ _ _	0.25 0.5 1.0	_ _ _	0.0005 0.0010 0.0015	0.25 0.5 1.0	_ _ _	7.5 15 30	μAdc
Total Supply Current <sup>(5.)</sup> (6 (Dynamic plus Quiesce Per Gate, C <sub>L</sub> = 50 pF)		I <sub>T</sub>	5.0 10 15			$I_{T} = (0.$	3 μΑ/kHz) f - 6 μΑ/kHz) f - 9 μΑ/kHz) f -	+ I <sub>DD</sub> /N			μAdc

- 4. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
- 5. The formulas given are for the typical characteristics only at 25  $^{\circ}\text{C}.$
- 6. To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$$

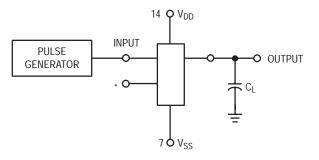
where:  $I_T$  is in  $\mu A$  (per package),  $C_L$  in pF,  $V = (V_{DD} - V_{SS})$  in volts, f in kHz is input frequency, and k = 0.001 x the number of exercised gates per package.

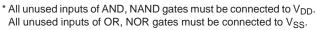
### **B-SERIES GATE SWITCHING TIMES**

# SWITCHING CHARACTERISTICS (7.) $(C_L = 50 \text{ pF}, T_A = 25^{\circ}\text{C})$

Characteristic	Symbol	V <sub>DD</sub> Vdc	Min	Тур <sup>(8.)</sup>	Max	Unit
Output Rise Time $t_{TLH} = (1.35 \text{ ns/pF}) \text{ C}_L + 33 \text{ ns} \\ t_{TLH} = (0.60 \text{ ns/pF}) \text{ C}_L + 20 \text{ ns} \\ t_{TLH} = (0.40 \text{ ns/PF}) \text{ C}_L + 20 \text{ ns}$	t <sub>TLH</sub>	5.0 10 15		100 50 40	200 100 80	ns
Output Fall Time $t_{THL} = (1.35 \text{ ns/pF}) \text{ C}_L + 33 \text{ ns} \\ t_{THL} = (0.60 \text{ ns/pF}) \text{ C}_L + 20 \text{ ns} \\ t_{THL} = (0.40 \text{ ns/pF}) \text{ C}_L + 20 \text{ ns}$	t <sub>THL</sub>	5.0 10 15	_ _ _	100 50 40	200 100 80	ns
Propagation Delay Time $t_{PLH},t_{PHL}=(0.90\;\text{ns/pF})\;C_L+115\;\text{ns}$ $t_{PLH},t_{PHL}=(0.36\;\text{ns/pF})\;C_L+47\;\text{ns}$ $t_{PLH},t_{PHL}=(0.26\;\text{ns/pF})\;C_L+37\;\text{ns}$	t <sub>PLH</sub> , t <sub>PHL</sub>	5.0 10 15	_ _ _	160 65 50	300 130 100	ns

- 7. The formulas given are for the typical characteristics only at 25°C.
  8. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.





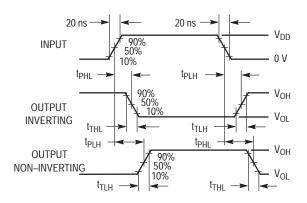
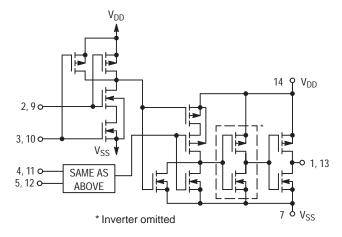


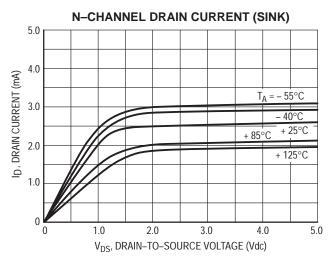
Figure 1. Switching Time Test Circuit and Waveforms

#### **CIRCUIT SCHEMATIC**

### MC14012B One of Two Gates Shown



### TYPICAL B-SERIES GATE CHARACTERISTICS



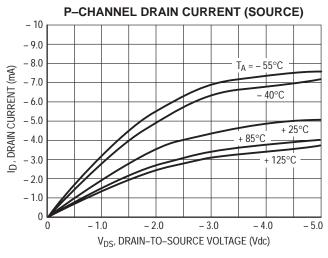
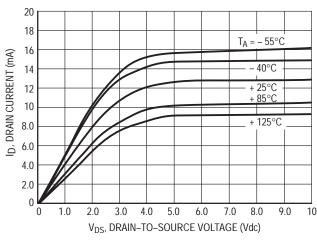


Figure 2.  $V_{GS} = 5.0 \text{ Vdc}$ 

Figure 3.  $V_{GS} = -5.0 \text{ Vdc}$ 



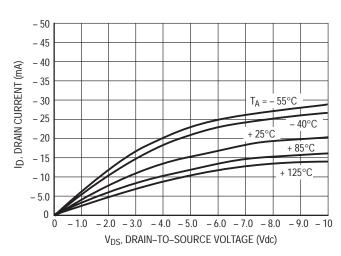
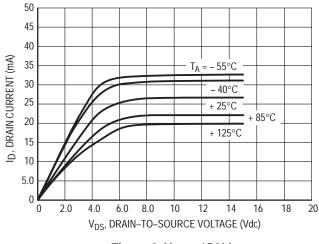


Figure 4. V<sub>GS</sub> = 10 Vdc

Figure 5.  $V_{GS} = -10 \text{ Vdc}$ 



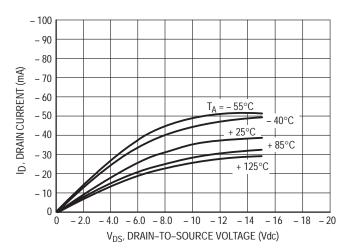


Figure 6. V<sub>GS</sub> = 15 Vdc

Figure 7.  $V_{GS} = -15 \text{ Vdc}$ 

These typical curves are not guarantees, but are design aids. Caution: The maximum rating for output current is 10 mA per pin.

# TYPICAL B-SERIES GATE CHARACTERISTICS (cont'd)

#### **VOLTAGE TRANSFER CHARACTERISTICS**

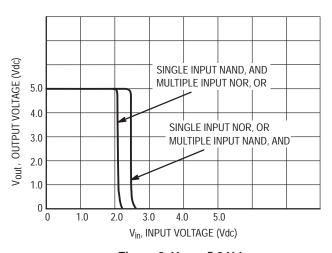


Figure 8.  $V_{DD} = 5.0 \text{ Vdc}$ 

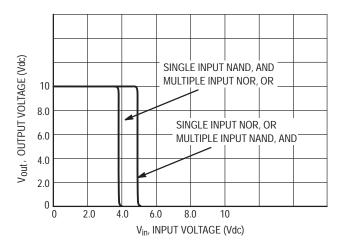


Figure 9. V<sub>DD</sub> = 10 Vdc

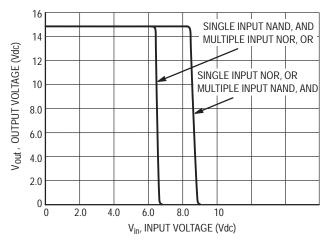


Figure 10.  $V_{DD} = 15 \text{ Vdc}$ 

#### DC NOISE MARGIN

The DC noise margin is defined as the input voltage range from an ideal "1" or "0" input level which does not produce output state change(s). The typical and guaranteed limit values of the input values  $V_{IL}$  and  $V_{IH}$  for the output(s) to be at a fixed voltage  $V_O$  are given in the Electrical Characteristics table.  $V_{IL}$  and  $V_{IH}$  are presented graphically in Figure 11.

Guaranteed minimum noise margins for both the "1" and "0" levels =

1.0 V with a 5.0 V supply

2.0 V with a 10.0 V supply

2.5 V with a 15.0 V supply

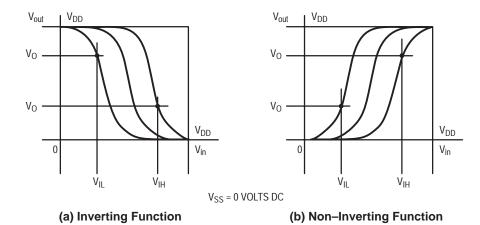
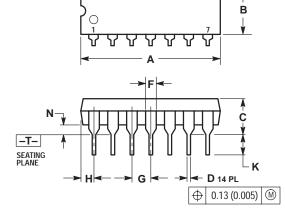


Figure 11. DC Noise Immunity

### **PACKAGE DIMENSIONS**

#### **P SUFFIX**

PLASTIC DIP PACKAGE CASE 646-06 **ISSUE M** 

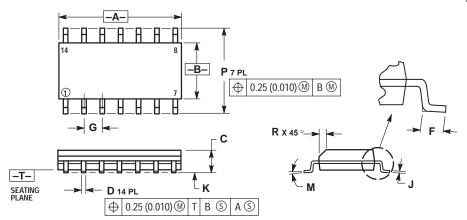




- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
   DIMENSION B DOES NOT INCLUDE MOLD FLASH.
- 5. ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.715	0.770	18.16	18.80
В	0.240	0.260	6.10	6.60
С	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
Н	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.290	0.310	7.37	7.87
М		10°		10°
N	0.015	0.039	0.38	1.01

#### **D SUFFIX** PLASTIC SOIC PACKAGE CASE 751A-03 ISSUE F



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
  Y14.5M, 1982.

- Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.

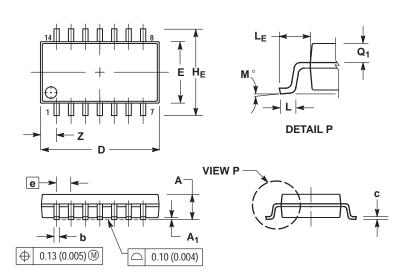
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.

  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	METERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	8.55	8.75	0.337	0.344	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050 BSC		
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0 °	7°	0°	7°	
Р	5.80	6.20	0.228	0.244	
R	0.25	0.50	0.010	0.019	

### **PACKAGE DIMENSIONS**

#### **F SUFFIX** PLASTIC EIAJ SOIC PACKAGE CASE 965-01 **ISSUE O**



# NOTES:

- JIES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE
- MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

  4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

  5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018). TO BE 0.46 (0.018).

	MILLIN	METERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α		2.05		0.081	
A <sub>1</sub>	0.05	0.20	0.002	0.008	
b	0.35	0.50	0.014	0.020	
С	0.18	0.27	0.007	0.011	
D	9.90	10.50	0.390	0.413	
Ε	5.10	5.45	0.201	0.215	
е	1.27	1.27 BSC		BSC	
HE	7.40	8.20	0.291	0.323	
0.50	0.50	0.85	0.020	0.033	
LE	1.10	1.50	0.043	0.059	
M	0 °	10 °	0 °	10 °	
Q <sub>1</sub>	0.70	0.90	0.028	0.035	
Z		1.42		0.056	

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